

Vishay General Semiconductor

Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier





| Available | |
|-----------|--|
| | |
| | |

| PRIMARY CHARACTERISTICS | | | | |
|---|---------------------|--|--|--|
| I _{F(AV)} | 2 A | | | |
| V _{RRM} | 60 V | | | |
| I _{FSM} | 60 A | | | |
| V _F at I _F = 2 A (125 °C) | 0.46 V | | | |
| T _J max. | 175 °C | | | |
| Package | SlimSMAW (DO-221AD) | | | |
| Circuit configuration | Single | | | |

FEATURES

- Low-profile package
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- FREE Compatible to SOD-128 package case outline
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SlimSMAW (DO-221AD) Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 gualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

| MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted) | | | | |
|---|-----------------------------------|-------------|------|--|
| PARAMETER | SYMBOL | VSS8D2M6 | UNIT | |
| Device marking code | | V2M6 | | |
| Maximum repetitive peak reverse voltage | V _{RRM} | 60 | V | |
| Maximum average forward rectified current (fig.1) | I _{F(AV)} ⁽¹⁾ | 2 | А | |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I _{FSM} | 60 | A | |
| Operating junction temperature range | T _J ⁽³⁾ | -40 to +175 | | |
| Storage temperature range | T _{STG} | -55 to +175 | | |

Notes

⁽¹⁾ Free air, mounted on recommended copper pad area

 $^{(2)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: dP_D/dT_J < 1/R_{0JA}



RoHS

COMPLIANT

HALOGEN





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| ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted) | | | | | | |
|---|-----------------------|---|-------------------------------|------|------|------|
| PARAMETER | TEST CO | TEST CONDITIONS | | TYP. | MAX. | UNIT |
| Instantaneous forward voltage | I _F = 1 A | $\begin{array}{c} I_F = 1 \text{ A} \\ \hline I_F = 2 \text{ A} \end{array} T_A = 25 \text{ °C} \end{array}$ | | 0.48 | - | - V |
| | $I_F = 2 A$ | | V _E (1) | 0.54 | 0.62 | |
| | I _F = 1 A | – T _A = 125 °C | VF () | 0.36 | - | |
| | I _F = 2 A | | C | 0.46 | 0.54 | |
| Reverse current | V - 60 V | T _A = 25 °C T _A = 125 °C | I _R ⁽²⁾ | - | 0.2 | mA |
| | V _R = 60 V | | 'R (=) | 1.5 | 5.0 | |
| Typical junction capacitance | 4.0 V, 1 MH | 4.0 V, 1 MHz | | 430 | - | pF |

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: pulse width \leq 5 ms

| THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise specified) | | | | |
|--|------------------------------------|------|------|------|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
| Typical thermal resistance | R _{0JA} ⁽¹⁾⁽²⁾ | 120 | 150 | °C/W |
| | R _{θJM} ⁽³⁾ | 12 | 15 | 0/11 |

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint

(3) Thermal resistance junction-to-mount to follow JEDEC 51-14 transient dual interface test method (TDIM)

| ORDERING INFORMATION (Example) | | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | |
| VSS8D2M6-M3/H | 0.033 | Н | 3500 | 7" diameter plastic tape and reel | |
| VSS8D2M6-M3/I | 0.033 | I | 14 000 | 13" diameter plastic tape and reel | |
| VSS8D2M6HM3/H (1) | 0.033 | Н | 3500 | 7" diameter plastic tape and reel | |
| VSS8D2M6HM3/I ⁽¹⁾ | 0.033 | Ι | 14 000 | 13" diameter plastic tape and reel | |

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

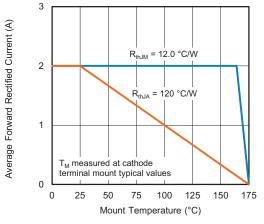


Fig. 1 - Maximum Forward Current Derating Curve

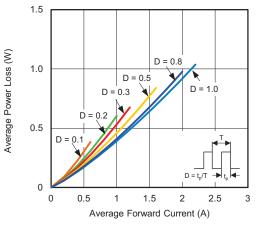


Fig. 2 - Forward Power Loss Characteristics

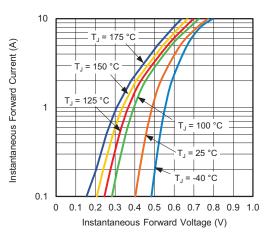


Fig. 3 - Typical Instantaneous Forward Characteristics

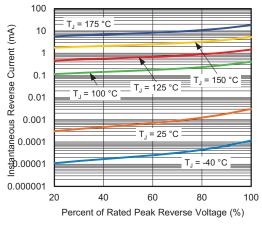


Fig. 4 - Typical Reverse Leakage Characteristics

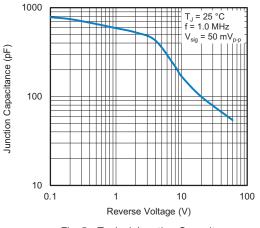


Fig. 5 - Typical Junction Capacitance

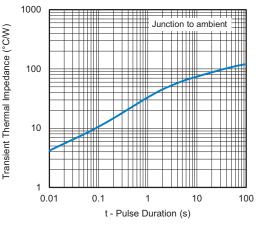


Fig. 6 - Typical Transient Thermal Impedance

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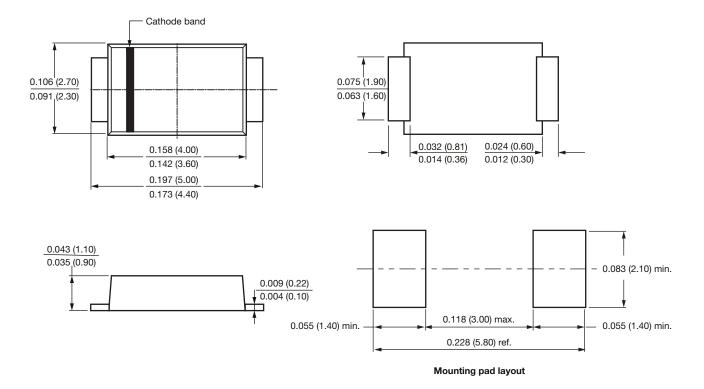


VSS8D2M6

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SlimSMAW (DO-221AD)





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